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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Discontinued at Digi-Key
Core Processor	XC800
Core Size	8-Bit
Speed	27MHz
Connectivity	CANbus, SPI, SSI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	40
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	3.25K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	PG-LQFP-64-4
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/saf-xc878cm-16ffi-3v3-aa

1 Summary of Features

The XC87x has the following features:

- High-performance XC800 Core
  - compatible with standard 8051 processor
  - two clocks per machine cycle architecture (for memory access without wait state)
  - two data pointers
- On-chip memory
  - 8 Kbytes of Boot ROM
  - 256 bytes of RAM
  - 3 Kbytes of XRAM
  - 64/52 Kbytes of Flash;
    (includes memory protection strategy)
- I/O port supply at 3.3 V or 5.0 V and core logic supply at 2.5 V (generated by embedded voltage regulator)

(more features on next page)

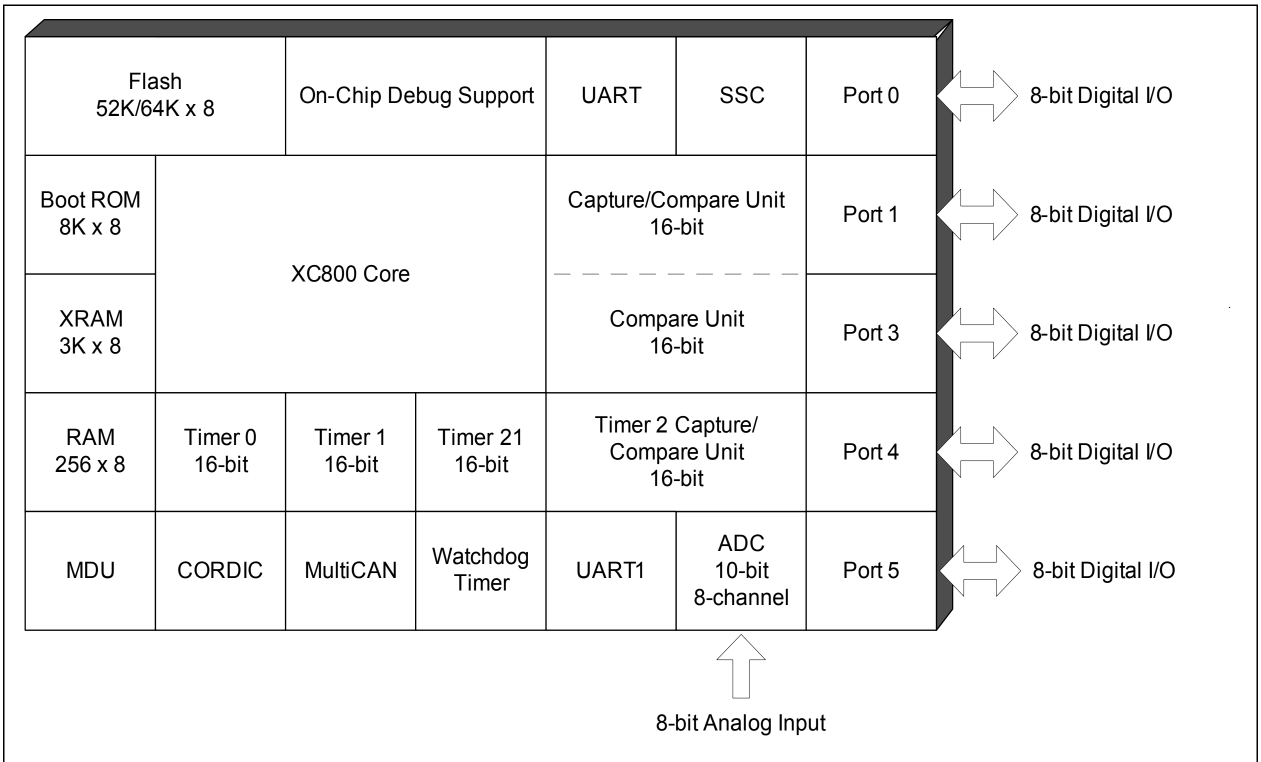

Figure 1 XC87x Functional Units

XC87x Variant Devices

The XC87x product family features devices with different configurations, program memory sizes, package options, power supply voltage, temperature and quality profiles (Automotive or Industrial), to offer cost-effective solutions for different application requirements.

The list of XC87x device configurations are summarized in **Table 1**. 2 types of packages are available :

- PG-LQFP-64, which is denoted by XC878 and;
- PG-VQFN-48, which is denoted by XC874

Table 1 Device Configuration

Device Name	CAN Module	LIN BSL Support	MDU Module
XC87x	No	No	No
XC87xM	No	No	Yes
XC87xCM	Yes	No	Yes
XC87xLM	No	Yes	Yes
XC87xCLM	Yes	Yes	Yes

From these 5 different combinations of configuration, each are further made available in many sales types, which are grouped according to device type, program memory sizes, power supply voltage, temperature and quality profiles (Automotive or Industrial), as shown in **Table 2**.

Table 2 Device Profile

Sales Type	Device Type	Program Memory (Kbytes)	Power Supply (V)	Temp-erature (°C)	Quality Profile
SAF-XC878-13FFI 5V	Flash	52	5.0	-40 to 85	Industrial
SAF-XC878M-13FFI 5V	Flash	52	5.0	-40 to 85	Industrial
SAF-XC878CM-13FFI 5V	Flash	52	5.0	-40 to 85	Industrial
SAF-XC878-16FFI 5V	Flash	64	5.0	-40 to 85	Industrial
SAF-XC878M-16FFI 5V	Flash	64	5.0	-40 to 85	Industrial
SAF-XC878CM-16FFI 5V	Flash	64	5.0	-40 to 85	Industrial
SAF-XC878-13FFI 3V3	Flash	52	3.3	-40 to 85	Industrial
SAF-XC878M-13FFI 3V3	Flash	52	3.3	-40 to 85	Industrial

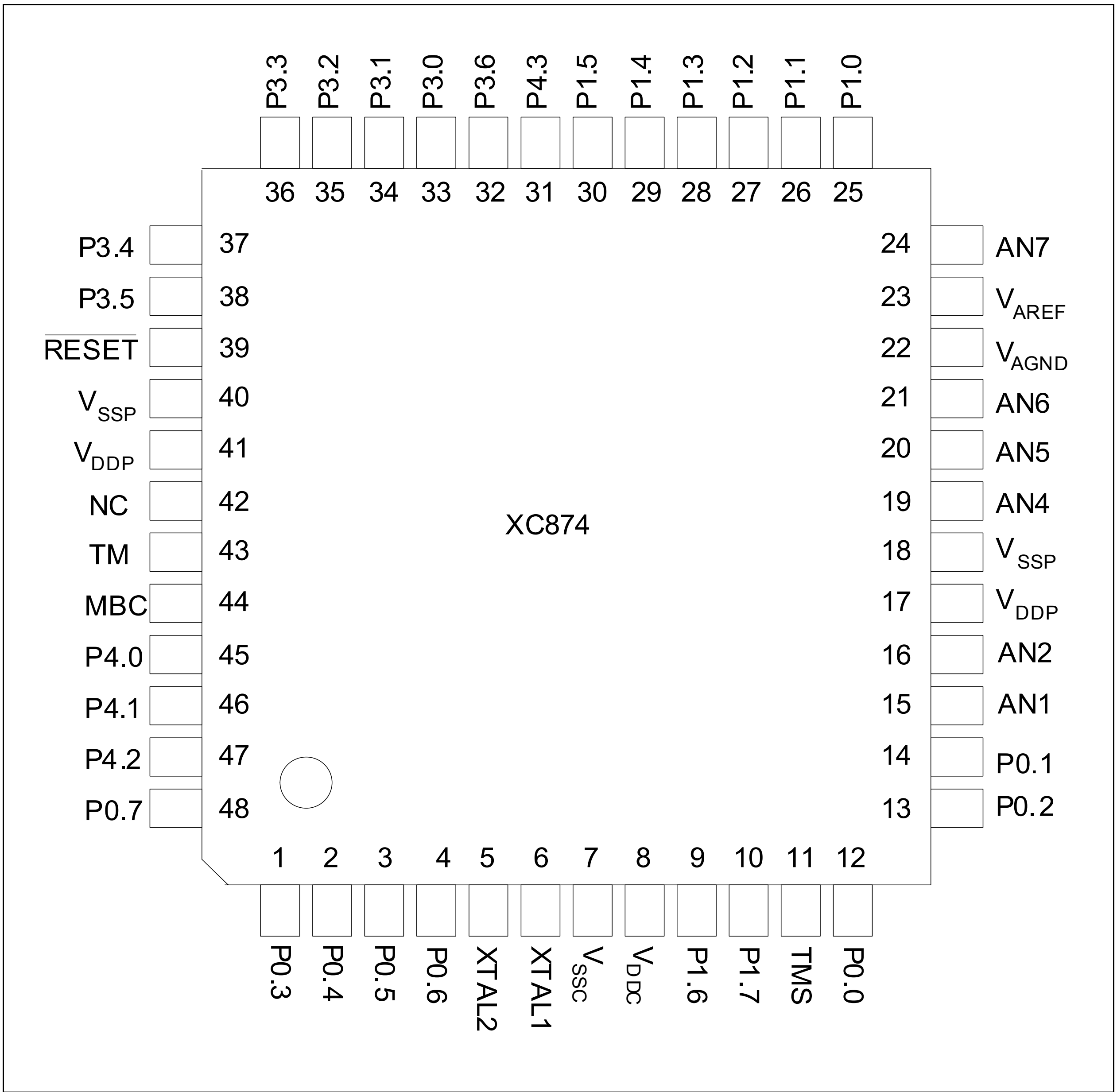

Figure 5 XC874 Pin Configuration, PG-VQFN-48 Package (top view)

Table 3 Pin Definitions and Functions (cont'd)

Symbol	Pin Number (LQFP-64 / VQFN-48)	Type	Reset State	Function	
P0.3	63/1		Hi-Z	SCK_1 COUT63_1 RXDO1_0 A17	SSC Clock Input/Output Output of Capture/Compare channel 3 UART1 Transmit Data Output Address Line 17 Output
P0.4	64/2		Hi-Z	MTSR_1 CC62_1 TXD1_0 A18	SSC Master Transmit Output/ Slave Receive Input Input/Output of Capture/Compare channel 2 UART1 Transmit Data Output/Clock Output Address Line 18 Output
P0.5	1/3		Hi-Z	MRST_1 EXINT0_0 T2EX1_1 RXD1_0 COUT62_1 A19	SSC Master Receive Input/Slave Transmit Output External Interrupt Input 0 Timer 21 External Trigger Input UART1 Receive Data Input Output of Capture/Compare channel 2 Address Line 19 Output
P0.6	2/4		PU	T2CC4_1 $\overline{WR}$	Compare Output Channel 4 External Data Write Control Output
P0.7	62/48		PU	CLKOUT_1 T2CC5_1 $\overline{RD}$	Clock Output Compare Output Channel 5 External Data Read Control Output

Table 3 Pin Definitions and Functions (cont'd)

Symbol	Pin Number (LQFP-64 / VQFN-48)	Type	Reset State	Function
P1		I/O		**Port 1** Port 1 is an 8-bit bidirectional general purpose I/O port. It can be used as alternate functions for the JTAG, CCU6, UART, Timer 0, Timer 1, T2CCU, Timer 21, MultiCAN, SSC and External Bus Interface. *Note: External Bus Interface is not available in XC874.*
P1.0	34/25		PU	RXD_0 UART Receive Data Input T2EX_0 Timer 2 External Trigger Input RXDC0_0 MultiCAN Node 0 Receiver Input A8 Address Line 8 Output
P1.1	35/26		PU	EXINT3_0 External Interrupt Input 3 T0_1 Timer 0 Input TXD_0 UART Transmit Data Output/Clock Output TXDC0_0 MultiCAN Node 0 Transmitter Output A9 Address Line 9 Output
P1.2	36/27		PU	SCK_0 SSC Clock Input/Output A10 Address Line 10 Output
P1.3	37/28		PU	MTSR_0 SSC Master Transmit Output/Slave Receive Input SCK_2 SSC Clock Input/Output TXDC1_3 MultiCAN Node 1 Transmitter Output A11 Address Line 11 Output
P1.4	38/29		PU	MRST_0 SSC Master Receive Input/ Slave Transmit Output EXINT0_1 External Interrupt Input 0 RXDC1_3 MultiCAN Node 1 Receiver Input MTSR_2 SSC Master Transmit Output/Slave Receive Input A12 Address Line 12 Output

Table 4 Flash Protection Modes (cont'd)

Flash Protection	**Without hardware protection**	**With hardware protection**	
P-Flash program and erase	Possible	Possible only on the condition that MSB - 1 of password is set to 1	Possible only on the condition that MSB - 1 of password is set to 1
D-Flash contents can be read by	Read instructions in any program memory	Read instructions in any program memory	Read instructions in the P-Flash or D-Flash
External access to D-Flash	Not possible	Not possible	Not possible
D-Flash program	Possible	Possible	Possible, on the condition that MSB - 1 of password is set to 1
D-Flash erase	Possible	Possible, on these conditions: • MISC_CON.DFLASHEN bit is set to 1 prior to each erase operation; or • the MSB - 1 of password is set to 1	Possible, on the condition that MSB - 1 of password is set to 1

BSL mode 6, which is used for enabling Flash protection, can also be used for disabling Flash protection. Here, the programmed password must be provided by the user. To disable the flash protection, a password match is required. A password match triggers an automatic erase of the protected P-Flash and D-Flash contents, including the programmed password. With a valid password, the Flash hardware protection is then enabled or disabled upon next reset. For the other protection strategies, no reset is necessary.

Although no protection scheme can be considered infallible, the XC87x memory protection strategy provides a very high level of protection for a general purpose microcontroller.

Note: If ROM read-out protection is enabled, only read instructions in the ROM memory can target the ROM contents.

Table 10 Port Register Overview (cont'd)

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
91_H	**P1_ALTSEL1** **Reset: 00_H** P1 Alternate Select 1 Register	Bit Field	P7	P6	P5	P4	P3	P2	P1	P0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
92_H	**P5_ALTSEL0** **Reset: 00_H** P5 Alternate Select 0 Register	Bit Field	P7	P6	P5	P4	P3	P2	P1	P0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
93_H	**P5_ALTSEL1** **Reset: 00_H** P5 Alternate Select 1 Register	Bit Field	P7	P6	P5	P4	P3	P2	P1	P0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
$B0_H$	**P3_ALTSEL0** **Reset: 00_H** P3 Alternate Select 0 Register	Bit Field	P7	P6	P5	P4	P3	P2	P1	P0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
$B1_H$	**P3_ALTSEL1** **Reset: 00_H** P3 Alternate Select 1 Register	Bit Field	P7	P6	P5	P4	P3	P2	P1	P0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
$C8_H$	**P4_ALTSEL0** **Reset: 00_H** P4 Alternate Select 0 Register	Bit Field	P7	P6	P5	P4	P3	P2	P1	P0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
$C9_H$	**P4_ALTSEL1** **Reset: 00_H** P4 Alternate Select 1 Register	Bit Field	P7	P6	P5	P4	P3	P2	P1	P0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
RMAP = 0, PAGE 3										
80_H	**P0_OD** **Reset: 00_H** P0 Open Drain Control Register	Bit Field	P7	P6	P5	P4	P3	P2	P1	P0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
86_H	**P0_DS** **Reset: FF_H** P0 Drive Strength Control Register	Bit Field	P7	P6	P5	P4	P3	P2	P1	P0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
90_H	**P1_OD** **Reset: 00_H** P1 Open Drain Control Register	Bit Field	P7	P6	P5	P4	P3	P2	P1	P0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
91_H	**P1_DS** **Reset: FF_H** P1 Drive Strength Control Register	Bit Field	P7	P6	P5	P4	P3	P2	P1	P0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
92_H	**P5_OD** **Reset: 00_H** P5 Open Drain Control Register	Bit Field	P7	P6	P5	P4	P3	P2	P1	P0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
93_H	**P5_DS** **Reset: FF_H** P5 Drive Strength Control Register	Bit Field	P7	P6	P5	P4	P3	P2	P1	P0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
$B0_H$	**P3_OD** **Reset: 00_H** P3 Open Drain Control Register	Bit Field	P7	P6	P5	P4	P3	P2	P1	P0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
$B1_H$	**P3_DS** **Reset: FF_H** P3 Drive Strength Control Register	Bit Field	P7	P6	P5	P4	P3	P2	P1	P0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
$C8_H$	**P4_OD** **Reset: 00_H** P4 Open Drain Control Register	Bit Field	P7	P6	P5	P4	P3	P2	P1	P0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
$C9_H$	**P4_DS** **Reset: FF_H** P4 Drive Strength Control Register	Bit Field	P7	P6	P5	P4	P3	P2	P1	P0
		Type	rw	rw	rw	rw	rw	rw	rw	rw

Table 11 ADC Register Overview (cont'd)

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
CB_H	**ADC_RCR1** **Reset: 00_H** Result Control Register 1	Bit Field	VFCTR	WFR	0	IEN	0			DRCTR
		Type	rw	rw	r	rw	r			rw
CC_H	**ADC_RCR2** **Reset: 00_H** Result Control Register 2	Bit Field	VFCTR	WFR	0	IEN	0			DRCTR
		Type	rw	rw	r	rw	r			rw
CD_H	**ADC_RCR3** **Reset: 00_H** Result Control Register 3	Bit Field	VFCTR	WFR	0	IEN	0			DRCTR
		Type	rw	rw	r	rw	r			rw
CE_H	**ADC_VFCR** **Reset: 00_H** Valid Flag Clear Register	Bit Field	0				VFC3	VFC2	VFC1	VFC0
		Type	r				w	w	w	w
RMAP = 0, PAGE 5										
CA_H	**ADC_CHINFR** **Reset: 00_H** Channel Interrupt Flag Register	Bit Field	CHINF7	CHINF6	CHINF5	CHINF4	CHINF3	CHINF2	CHINF1	CHINF0
		Type	rh	rh	rh	rh	rh	rh	rh	rh
CB_H	**ADC_CHINCR** **Reset: 00_H** Channel Interrupt Clear Register	Bit Field	CHINC7	CHINC6	CHINC5	CHINC4	CHINC3	CHINC2	CHINC1	CHINC0
		Type	w	w	w	w	w	w	w	w
CC_H	**ADC_CHINSR** **Reset: 00_H** Channel Interrupt Set Register	Bit Field	CHINS7	CHINS6	CHINS5	CHINS4	CHINS3	CHINS2	CHINS1	CHINS0
		Type	w	w	w	w	w	w	w	w
CD_H	**ADC_CHINPR** **Reset: 00_H** Channel Interrupt Node Pointer Register	Bit Field	CHINP7	CHINP6	CHINP5	CHINP4	CHINP3	CHINP2	CHINP1	CHINP0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
CE_H	**ADC_EVINFR** **Reset: 00_H** Event Interrupt Flag Register	Bit Field	EVINF7	EVINF6	EVINF5	EVINF4	0		EVINF1	EVINF0
		Type	rh	rh	rh	rh	r		rh	rh
CF_H	**ADC_EVINCR** **Reset: 00_H** Event Interrupt Clear Flag Register	Bit Field	EVINC7	EVINC6	EVINC5	EVINC4	0		EVINC1	EVINC0
		Type	w	w	w	w	r		w	w
$D2_H$	**ADC_EVINSR** **Reset: 00_H** Event Interrupt Set Flag Register	Bit Field	EVINS7	EVINS6	EVINS5	EVINS4	0		EVINS1	EVINS0
		Type	w	w	w	w	r		w	w
$D3_H$	**ADC_EVINPR** **Reset: 00_H** Event Interrupt Node Pointer Register	Bit Field	EVINP7	EVINP6	EVINP5	EVINP4	0		EVINP1	EVINP0
		Type	rw	rw	rw	rw	r		rw	rw
RMAP = 0, PAGE 6										
CA_H	**ADC_CRCR1** **Reset: 00_H** Conversion Request Control Register 1	Bit Field	CH7	CH6	CH5	CH4	0			
		Type	rwh	rwh	rwh	rwh	r			
CB_H	**ADC_CRPR1** **Reset: 00_H** Conversion Request Pending Register 1	Bit Field	CHP7	CHP6	CHP5	CHP4	0			
		Type	rwh	rwh	rwh	rwh	r			

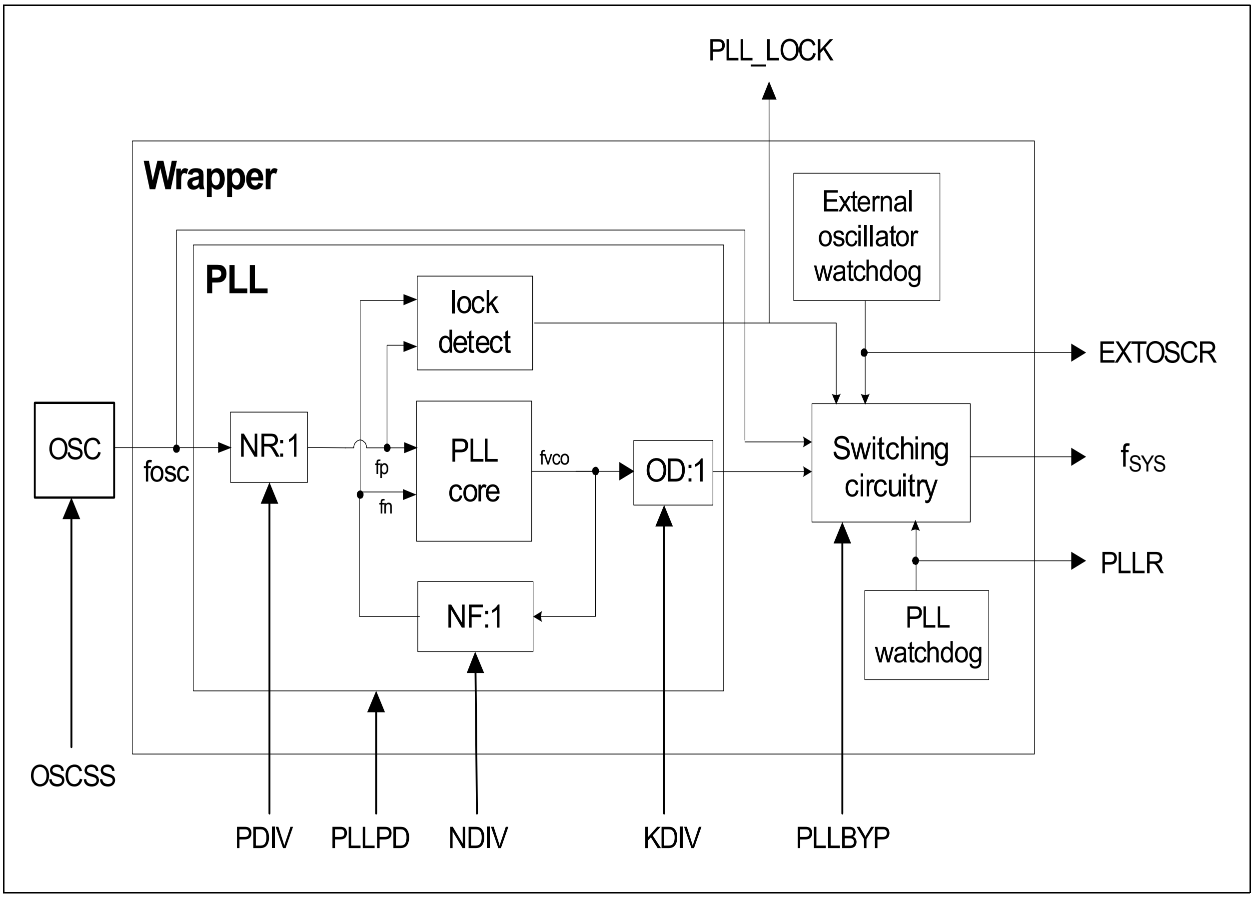

Figure 20 CGU Block Diagram

Direct Drive (PLL Bypass Operation)

During PLL bypass operation, the system clock has the same frequency as the external clock source.

(3.1)

$$f_{SYS} = f_{OSC}$$

PLL Mode

The CPU clock is derived from the oscillator clock, divided by the NR factor (PDIV), multiplied by the NF factor (NDIV), and divided by the OD factor (KDIV). PLL output must

For power saving purposes, the clocks may be disabled or slowed down according to Table 27.

Table 27 System frequency (f_{sys} = 144 MHz)

Power Saving Mode	Action
Idle	Clock to the CPU is disabled.
Slow-down	Clocks to the CPU and all the peripherals are divided by a common programmable factor defined by bit field CMCON.CLKREL.
Power-down[1)]	Oscillator and PLL are switched off.

1) SAK product variant does not support power-down mode.

– Interrupt enabling and corresponding flag

3.13 UART and UART1

The XC87x provides two Universal Asynchronous Receiver/Transmitter (UART and UART1) modules for full-duplex asynchronous reception/transmission. Both are also receive-buffered, i.e., they can commence reception of a second byte before a previously received byte has been read from the receive register. However, if the first byte still has not been read by the time reception of the second byte is complete, one of the bytes will be lost.

Features

- Full-duplex asynchronous modes
  - 8-bit or 9-bit data frames, LSB first
  - Fixed or variable baud rate
- Receive buffered
- Multiprocessor communication
- Interrupt generation on the completion of a data transmission or reception

The UART modules can operate in the four modes shown in **Table 30**.

Table 30 UART Modes

Operating Mode	Baud Rate
Mode 0: 8-bit shift register	$f_{PCLK}/2$
Mode 1: 8-bit shift UART	Variable
Mode 2: 9-bit shift UART	$f_{PCLK}/32$ or $f_{PCLK}/64$ [1)]
Mode 3: 9-bit shift UART	Variable

1) For UART1 module, the baud rate is fixed at $f_{PCLK}/64$.

There are several ways to generate the baud rate clock for the serial port, depending on the mode in which it is operating. In mode 0, the baud rate for the transfer is fixed at $f_{PCLK}/2$. In mode 2, the baud rate is generated internally based on the UART input clock and can be configured to either $f_{PCLK}/32$ or $f_{PCLK}/64$. For UART1 module, only $f_{PCLK}/64$ is available. The variable baud rate is set by the underflow rate on the dedicated baud-rate generator. For UART module, the variable baud rate alternatively can be set by the overflow rate on Timer 1.

3.13.1 Baud-Rate Generator

Both UART modules have their own dedicated baud-rate generator, which is based on a programmable 8-bit reload value, and includes divider stages (i.e., prescaler and

Table 32 Deviation Error for UART with Fractional Divider enabled

f_{PCLK}	Prescaling Factor (2BRPRE)	Reload Value (BR_VALUE + 1)	STEP	Deviation Error
24 MHz	1	6 (6_H)	59 ($3B_H$)	+0.03 %
12 MHz	1	3 (3_H)	59 ($3B_H$)	+0.03 %
8 MHz	1	2 (2_H)	59 ($3B_H$)	+0.03 %
6 MHz	1	6 (6_H)	236 (EC_H)	+0.03 %

3.13.2 Baud Rate Generation using Timer 1

In UART modes 1 and 3 of UART module, Timer 1 can be used for generating the variable baud rates. In theory, this timer could be used in any of its modes. But in practice, it should be set into auto-reload mode (Timer 1 mode 2), with its high byte set to the appropriate value for the required baud rate. The baud rate is determined by the Timer 1 overflow rate and the value of SMOD as follows:

$$\text{Mode 1, 3 baud rate} = \frac{2^{SMOD} \times f_{PCLK}}{32 \times 2 \times (256 - TH1)} \tag{3.6}$$

3.14 Normal Divider Mode (8-bit Auto-reload Timer)

Setting bit FDM in register FDCON to 1 configures the fractional divider to normal divider mode, while at the same time disables baud rate generation (see **Figure 26**). Once the fractional divider is enabled (FDEN = 1), it functions as an 8-bit auto-reload timer (with no relation to baud rate generation) and counts up from the reload value with each input clock pulse. Bit field RESULT in register FDRES represents the timer value, while bit field STEP in register FDSTEP defines the reload value. At each timer overflow, an overflow flag (FDCON.NDOV) will be set and an interrupt request generated. This gives an output clock f_{MOD} that is 1/n of the input clock f_{DIV}, where n is defined by 256 - STEP.

The output frequency in normal divider mode is derived as follows:

$$f_{MOD} = f_{DIV} \times \frac{1}{256 - STEP} \tag{3.7}$$

3.21 Controller Area Network (MultiCAN)

The MultiCAN module contains two Full-CAN nodes operating independently or exchanging data and remote frames via a gateway function. Transmission and reception of CAN frames is handled in accordance to CAN specification V2.0 B active. Each CAN node can receive and transmit standard frames with 11-bit identifiers as well as extended frames with 29-bit identifiers.

Both CAN nodes share a common set of message objects, where each message object may be individually allocated to one of the CAN nodes. Besides serving as a storage container for incoming and outgoing frames, message objects may be combined to build gateways between the CAN nodes or to setup a FIFO buffer.

The message objects are organized in double chained lists, where each CAN node has it's own list of message objects. A CAN node stores frames only into message objects that are allocated to the list of the CAN node. It only transmits messages from objects of this list. A powerful, command driven list controller performs all list operations.

The bit timings for the CAN nodes are derived from the peripheral clock (f_{CAN}) and are programmable up to a data rate of 1 MBaud. A pair of receive and transmit pins connects each CAN node to a bus transceiver.

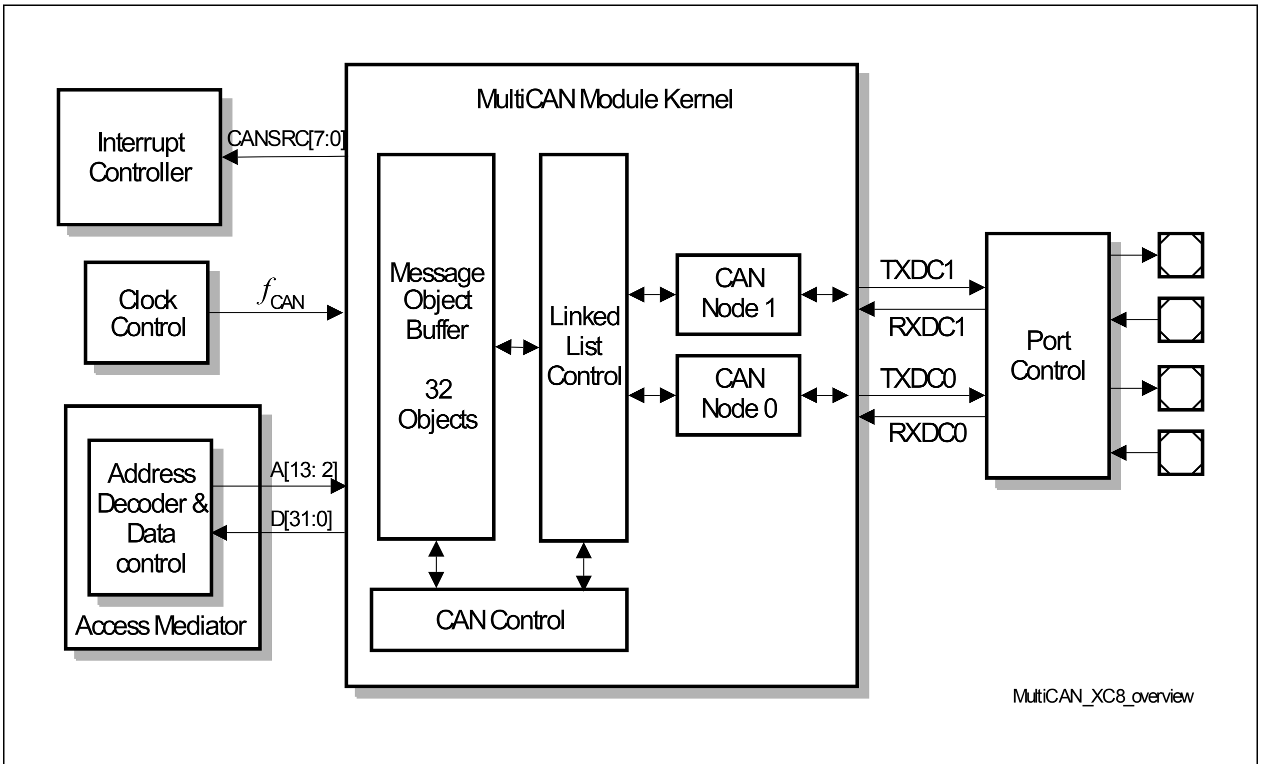

Figure 30 Overview of the MultiCAN

Features

- Compliant to ISO 11898.

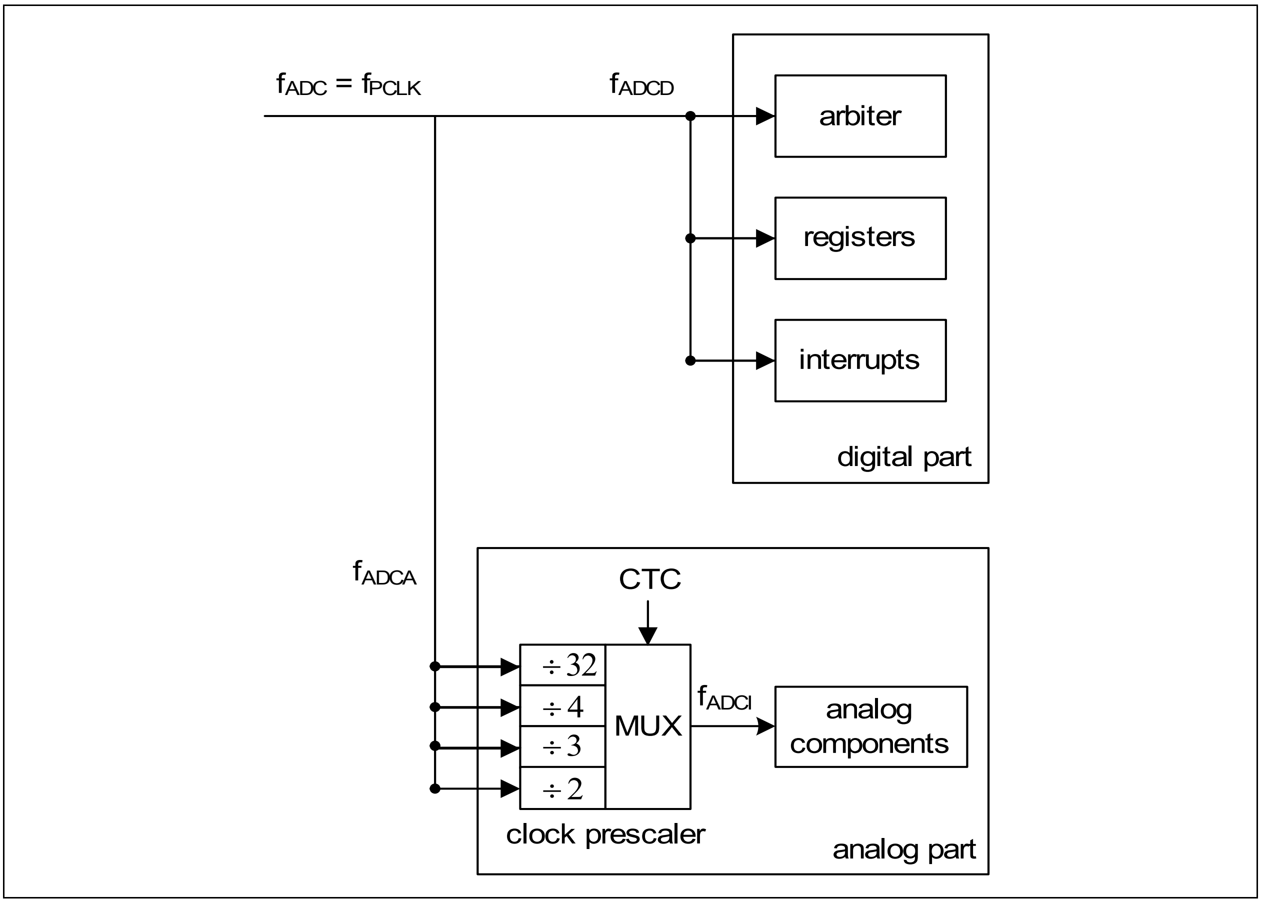

Figure 31 ADC Clocking Scheme

For module clock f_{ADC} = 24 MHz, the analog clock f_{ADCI} frequency can be selected as shown in **Table 35**.

Table 35 f_{ADCI} Frequency Selection

Module Clock f_{ADC}	CTC	Prescaling Ratio	Analog Clock f_{ADCI}
24 MHz	00_B	÷ 2	12 MHz
	01_B	÷ 3	8 MHz
	10_B	÷ 4	6 MHz
	11_B (default)	÷ 32	750 kHz

During slow-down mode, f_{ADC} may be reduced further, for example, to 12 MHz or 6 MHz. However, it is important to note that the conversion error could increase due to loss of charges on the capacitors, if f_{ADC} becomes too low during slow-down mode.

3.22.2 ADC Conversion Sequence

The analog-to-digital conversion procedure consists of the following phases:

Table 37 Chip Identification Number (cont'd)

Product Variant	Chip Identification Number
	AC-step
XC874CM-13FV 5V	$4B590402_H$
XC874LM-13FV 5V	$4B510422_H$
XC874-13FV 5V	$4B590462_H$

4.2 DC Parameters

The electrical characteristics of the DC Parameters are detailed in this section.

4.2.1 Input/Output Characteristics

Table 40 provides the characteristics of the input/output pins of the XC87x.

Table 40 Input/Output Characteristics (Operating Conditions apply)

Parameter	Symbol		Limit Values		Unit	Test Conditions
			min.	max.		
V_{DDP} = 5 V Range						
Output low voltage	V_{OL}	CC	–	0.6	V	I_{OL} = 9 mA (DS = 0)[1] I_{OL} = 12 mA (DS = 1)[2]
Output high voltage	V_{OH}	CC	2.4	–	V	I_{OH} = -20 mA (DS = 0)[1] I_{OH} = -25 mA (DS = 1)[2]
Input low voltage	V_{IL}	SR	-0.3	0.8	V	CMOS Mode
Input high voltage	V_{IH}	SR	2.2	V_{DDP}	V	CMOS Mode
Input Hysteresis	HYS	CC	0.35	–	V	CMOS Mode[3)7]
Input low voltage at XTAL1	V_{ILX}	SR	-0.3	0.8	V	
Input high voltage at XTAL1	V_{IHX}	SR	3.4	V_{DDP}	V	
Pull-up current	I_{PU}	SR	–	-20	µA	$V_{IH,min}$
			-88	–	µA	$V_{IL,max}$
Pull-down current	I_{PD}	SR	–	10	µA	$V_{IL,max}$
			66	–	µA	$V_{IH,min}$
Input leakage current	I_{OZ1}	CC	-1	1	µA	$0 < V_{IN} < V_{DDP}$, $T_A \leq 105°C$[4]
Overload current on any pin	I_{OV}	SR	-5	5	mA	
Absolute sum of overload currents	$\Sigma\|I_{OV}\|$	SR	–	25	mA	[5]
Voltage on any pin during V_{DDP} power off	V_{PO}	SR	–	0.3	V	[6]

Table 44 Power Down Current[1](Operating Conditions apply; V_{DDP} = 5V range)

Parameter	Symbol	Limit Values		Unit	Test Conditions
		typ.[2]	max.[3]		
V_{DDP} = 5V Range					
Power-Down Mode	I_{PDP}	20	80	μA	T_A = + 25 °C[4)5)]
		-	250	μA	T_A = + 85 °C[5)6)]

1) The table is only applicable to SAF and SAX variants. SAK variant does not support power-down mode
2) The typical I_{PDP} values are based on preliminary measurements and are to be used as reference only. These values are measured at V_{DDP} = 5.0 V.
3) The maximum I_{PDP} values are measured at V_{DDP} = 5.5 V.
4) I_{PDP} has a maximum value of 450 μA at T_A = + 105 °C.
5) I_{PDP} is measured with: $\overline{RESET}$ = V_{DDP}, V_{AGND}= V_{SS}, RXD/INT0 = V_{DDP}; rest of the ports are programmed to be input with either internal pull devices enabled or driven externally to ensure no floating inputs.
6) Not subjected to production test, verified by design/characterization.

Table 45 Power Supply Current Parameters[1] (Operating Conditions apply; V_{DDP} = 3.3V range)

Parameter	Symbol	Limit Values		Unit	Test Conditions
		typ.[2]	max.[3]		
V_{DDP} = 3.3V Range					
Active Mode	I_{DDP}	35.4	43	mA	[4]
Idle Mode	I_{DDP}	27.6	33	mA	[5]
Active Mode with slow-down enabled	I_{DDP}	8.6	13	mA	[6]
Idle Mode with slow-down enabled	I_{DDP}	8	12	mA	[7]

1) The table is only applicable to SAF and SAX variants.

2) The typical I_{DDP} values are based on preliminary measurements and are to be used as reference only. These values are periodically measured at T_A = + 25 °C and V_{DDP} = 3.3 V.

3) The maximum I_{DDP} values are measured under worst case conditions (T_A = + 105 °C and V_{DDP} = 3.6 V).

4) I_{DDP} (active mode) is measured with: CPU clock and input clock to all peripherals running at 24 MHz with on-chip oscillator of 4 MHz, $\overline{\text{RESET}}$ = V_{DDP}; all other pins are disconnected, no load on ports.

5) I_{DDP} (idle mode) is measured with: CPU clock disabled, watchdog timer disabled, input clock to all peripherals enabled and running at 24 MHz, $\overline{\text{RESET}}$ = V_{DDP}; all other pins are disconnected, no load on ports.

6) I_{DDP} (active mode with slow-down mode) is measured with: CPU clock and input clock to all peripherals running at 1 MHz by setting CLKREL in CMCON to 1000_B, $\overline{\text{RESET}}$ = V_{DDP}; all other pins are disconnected, no load on ports.

7) I_{DDP} (idle mode with slow-down mode) is measured with: CPU clock disabled, watchdog timer disabled, input clock to all peripherals enabled and running at 1 MHz by setting CLKREL in CMCON to 1000_B, $\overline{\text{RESET}}$ = V_{DDP}; all other pins are disconnected, no load on ports.

4.3.3 Power-on Reset and PLL Timing

Table 48 provides the characteristics of the power-on reset and PLL timing in the XC87x.

Table 48 Power-On Reset and PLL Timing (Operating Conditions apply)

Parameter	Symbol		Limit Values			Unit	Test Conditions
			min.	typ.	max.		
On-Chip Oscillator start-up time	t_{OSCST}	CC	–	–	500	ns	1)
PLL lock-in in time	t_{LOCK}	CC	–	–	200	μs	1)
PLL accumulated jitter	D_P		–	–	1.8	ns	1)2)

1) Not all parameters are 100% tested, but are verified by design/characterization and test correlation.

2) PLL lock at 144 MHz using a 4 MHz external oscillator. The PLL Divider settings are K = 2, N = 72 and P = 1.

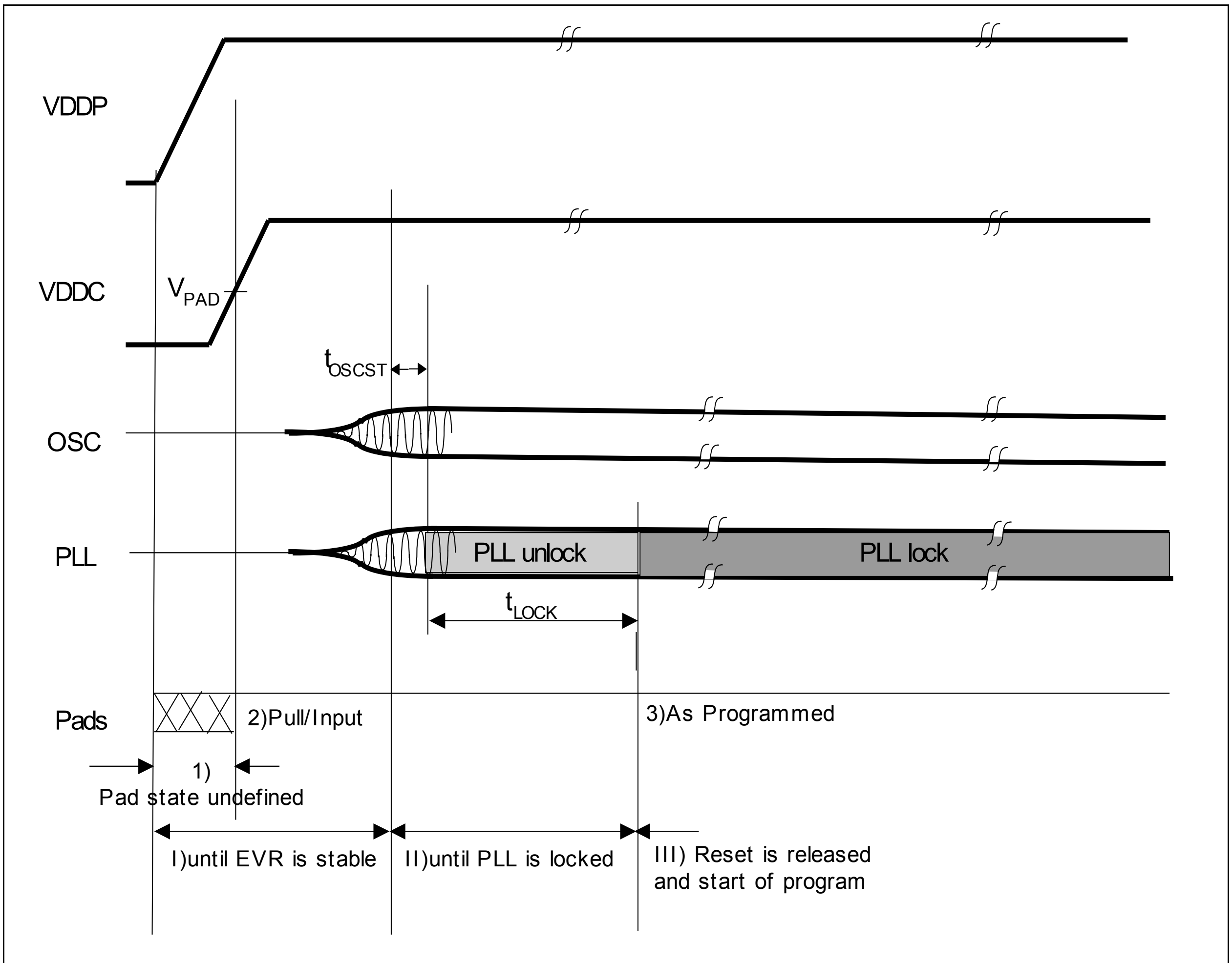

Figure 40 Power-on Reset Timing